

Product Information Sheet

MATERIAL ID: EPO-TEK® OD2002

Date: Feb 2012 Rev: VIII

Material Description: High Tg version of EPO-TEK®353ND with low modulus and good toughness. Replacement for

EPO-TEK® 364. Complies with USP Class VI biocompatibility standards.

Number of Components: Two Mix Ratio by Weight: 20:1

Cure Schedule (minimum): 150°C/5 Minutes - 120°C/15 Minutes - 100°C/30 Minutes

Specific Gravity: Part A: 1.20 Part B: 1.02

Pot Life: 4 Hours

Shelf Life: One year at room temperature

NOTE: Container(s) should be kept closed when not in use. Filled systems should be stirred thoroughly before mixing and prior to use.

-TOTAL MASS SHOULD NOT EXCEED 25 GRAMS -

MATERIAL CHARACTERISTICS: To be used as a guide only, not as a specification. Data below is not guaranteed. Different batches, conditions and applications yield differing results; Cure condition: 150°C/1 Hour

* denotes test on lot acceptance basis

PHYSCIAL PROPERTIES:				
* Color (before cure):	Part A: Cloudy	Part B: Amber		
* Consistency	Pourable paste			
* Viscosity (23°C): @ 2.5 rpm	24,000 - 42,00	00 cPs		
Thixotropic Index:	N/A			
* Glass Transition Temp:	> 140 °C (Dynamic Cure: 20—200°C /ISO 25 Min; Ramp -10—200°C @ 20°C/Min)			
Coefficient of Thermal Expans	sion (CTE):			
Below Tg:		45 x 10⁻⁶ in/in°C		
Above Tg:	18	87 x 10 ⁻⁶ in/in°C		
Shore D Hardness:	(69		
Lap Shear @ 23°C:	1,57	70 psi		
Die Shear @ 23°C:	>1	0 Kg	3,400 psi	
Degradation Temp:	44	43 °C		
Weight Loss:				
@ 200°C	< 0.0	05 %		
@ 250°C	< 0.0	05 %		
@ 300°C	< 0.0	05 %		
Operating Temp:				
Continuous:	- 55°C t			
Intermittent:	- 55°C t			
Storage Modulus:	263,29	91 psi		
Ion Content:			+	
Cl:		ppm	NA ⁺ :	ppm
$\mathrm{NH_4}^+$:		ppm	K ⁺ :	ppm
Particle Size:	N/	/A		

ELECTRICAL AND THERMAL PROPERTIES:		
Thermal Conductivity:	N/A	
Volume Resistivity @ 23°C:	$> 2 \times 10^{12}$ Ohm-cm	
Dielectric Constant (1KHz):	2.83	
Dissipation Factor (1KHz):	0.011	

OPTICAL PROPERTIES @ 23°C:			
Spectral Transmission:	>98% @ 800 - 1640 nm	69% @ 600 nm	
Index of Refraction:	1.5728 @ 589 nm		

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